



Antenna Datasheet

Product OC: YF0020EA

Version: 2.1

Date: 2024-06-07

Status: Released

Product Name: 5G FPC Antenna

Key Features:

Frequency Band: 600–6000 MHz

Dimensions: 90.3 × 15.3 mm

Efficiency: Up to 89.4 % (EVB)

RoHS and REACH Compliant

Overview

This Quectel embedded 5G FPC/PCB antenna covers 5G NR Sub-6 GHz frequency bands and is compatible with 4G/3G/2G/LPWA bands. Ground plane independent, it's designed to be mounted directly to the underside of either a plastic or non-metallic enclosure. Ease of integration with a cable and connector which can be customized to meet your product design and RF module. Used with other 5G antennas, it can achieve MIMO (multiple input, multiple output) antenna technology for wireless communications in which multiple antennas are used at both the source (transmitter) and the destination (receiver).

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1 Specification

Test Condition: Stick to ABS Board on 130 × 130 mm EVB Board & Free Space

Electrical	
Frequency Range	600–6000 MHz
Impedance	50 Ω
Polarization	Linear
Radiation Pattern	Omni-directional

Electrical - Detail													
SPEC	Band	Band	B71	B12 /B13 /B28	B5 /B8 /B26	B1 /B2 /B3	B40	Wi-Fi 2G	B38 /B41	B48	B42 /n77	n79	Wi-Fi 5G
	Freq. (MHz)	600– 700	700– 810	820– 960	1700– 2170	2300– 2400	2400– 2500	2500– 2690	3550– 3700	3300– 4200	4400– 5000	5150– 5850	
Max. VSWR	EVB	4.0	3.6	4.8	2.2	2.6	2.7	2.3	1.8	2.5	2.5	2.1	
	FS	13.8	3.3	1.9	2.3	1.5	1.6	1.8	1.4	1.9	2.6	1.9	
Max. Return Loss (dB)	EVB	-4.5	-4.9	-3.6	-8.3	-7.0	-6.7	-8.1	-10.8	-7.5	-7.2	-8.8	
	FS	-1.3	-5.5	-9.9	-7.9	-14.0	-13.2	-10.5	-15.3	-9.9	-6.9	-10.2	
AVG Eff. (%)	EVB	44.8	70.9	55.8	64.8	54.3	47.4	57.1	68.5	63.1	57.1	52.7	
	FS	7.5	46.4	46.5	63.0	67.1	68.1	62.5	67.1	61.2	47.5	55.7	
AVG AVG Gain (dB)	EVB	-3.5	-1.5	-2.6	-1.9	-2.7	-3.2	-2.5	-1.6	-2.0	-2.5	-2.8	
	FS	-12.8	-3.4	-3.3	-2.0	-1.7	-1.7	-2.1	-1.7	-2.2	-3.2	-2.5	
Max. Peak Gain (dBi)	EVB	0.3	2.2	2.2	4.3	3.2	2.0	4.3	4.2	4.5	2.7	3.2	
	FS	-2.3	0.4	0.5	3.3	4.2	3.7	3.3	3.0	3.3	2.1	1.7	

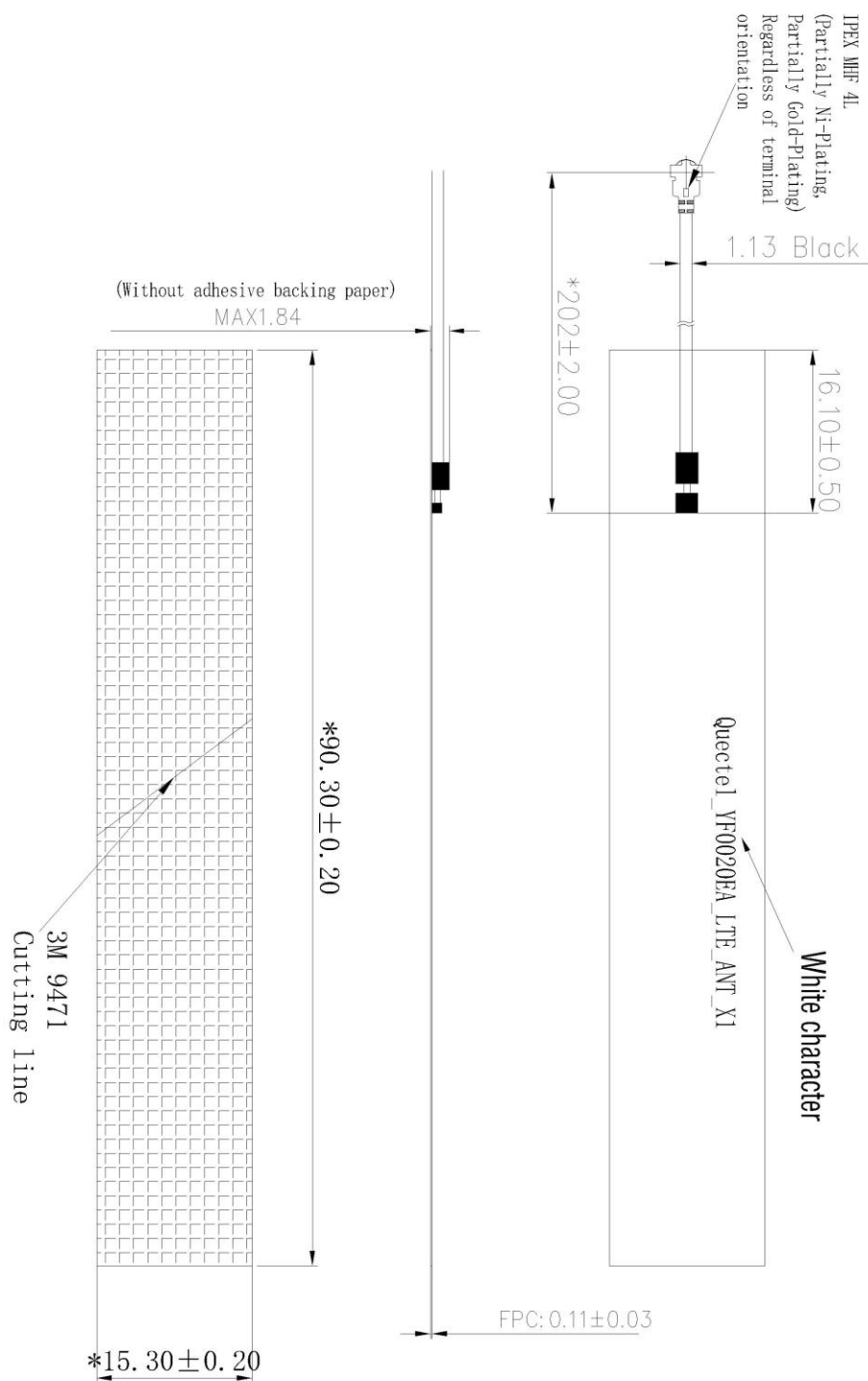
VSWR	EVB	≤ 4.8
	FS	≤ 13.8
Return Loss	EVB	≤ -3.6 dB
	FS	≤ -1.3 dB
Peak Gain	EVB	≤ 4.5 dBi
	FS	≤ 4.2 dBi

- EVB: Stick to ABS board on 130 × 130 mm EVB board
- FS: Free Space

1.1. Mechanical & Environmental

Mechanical	
Antenna Dimensions	90.3 × 15.3mm
Material & Color	FPC & Black
Cable Type & Color & Length	Φ1.13 & Black & 202 mm
Connector Type	IPEX MHF 4L
Mounting Type	Adhesive
Weight	Typ. 1.1 g
Environmental	
Operation Temperature	-40 °C to +85 °C
Storage Temperature	-40 °C to +85 °C
RoHS and REACH Compliant	Yes

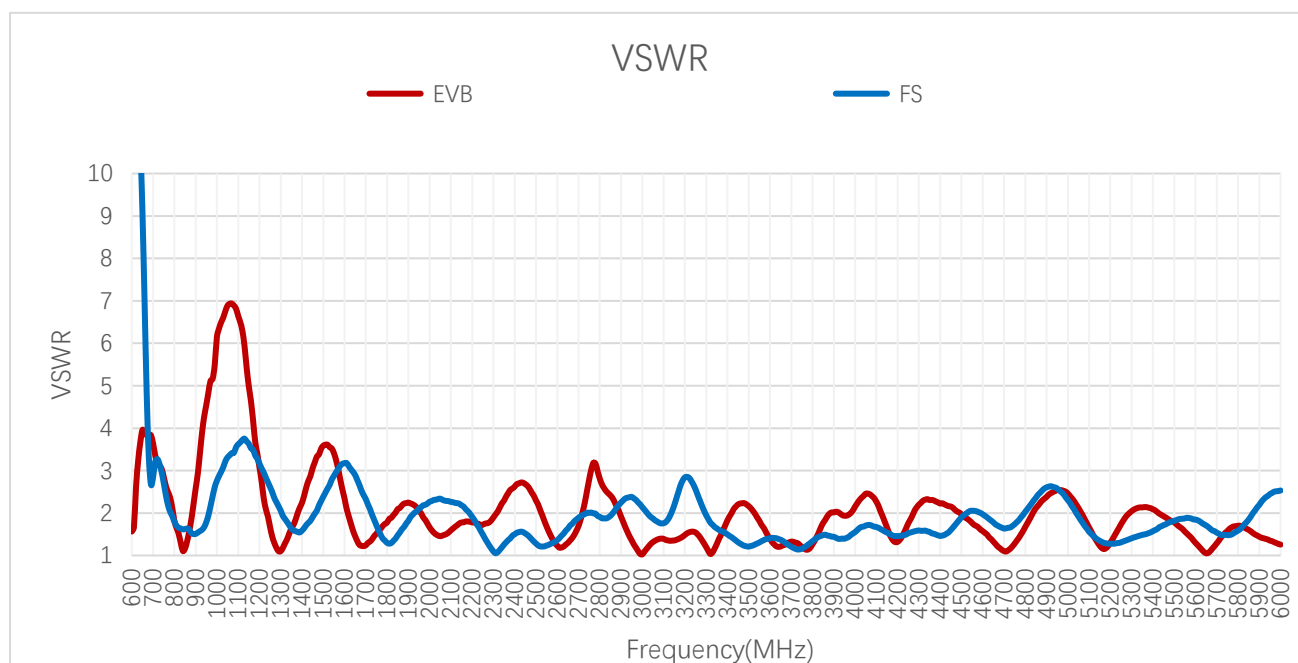
2 Drawing



3 Detailed Performance

3.1. S-Parameter Test

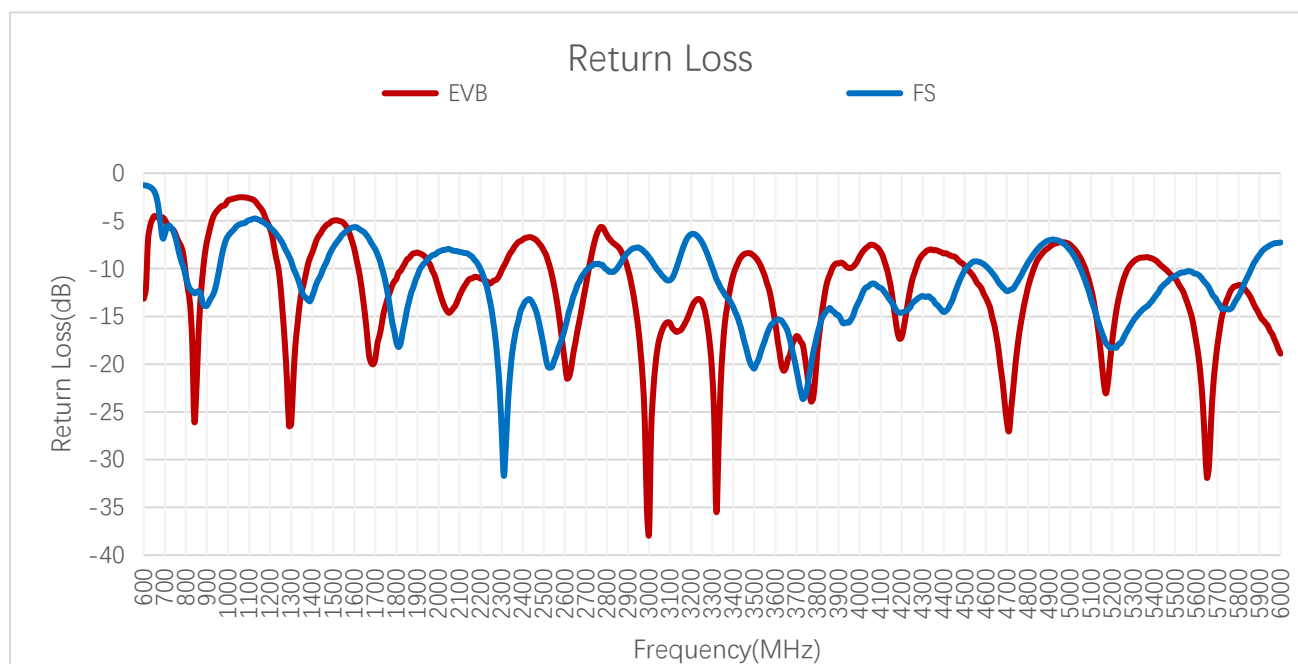
3.1.1. VSWR



VSWR

Frequency (MHz)		600	630	710	830	900	960	1440	1710	1740	1880
VSWR	EVB	1.6	3.2	3.4	1.3	2.6	4.8	2.9	1.3	1.5	2.2
	FS	13.8	11.9	3.2	1.6	1.5	1.9	1.8	2.2	1.8	1.7
Frequency (MHz)		1950	2140	2350	2450	2600	3600	4700	5000	5500	6000
VSWR	EVB	2.0	1.8	2.3	2.7	1.2	1.4	1.1	2.5	1.8	1.3
	FS	2.1	2.2	1.3	1.5	1.4	1.4	1.6	2.3	1.8	2.5

3.1.2. Return Loss

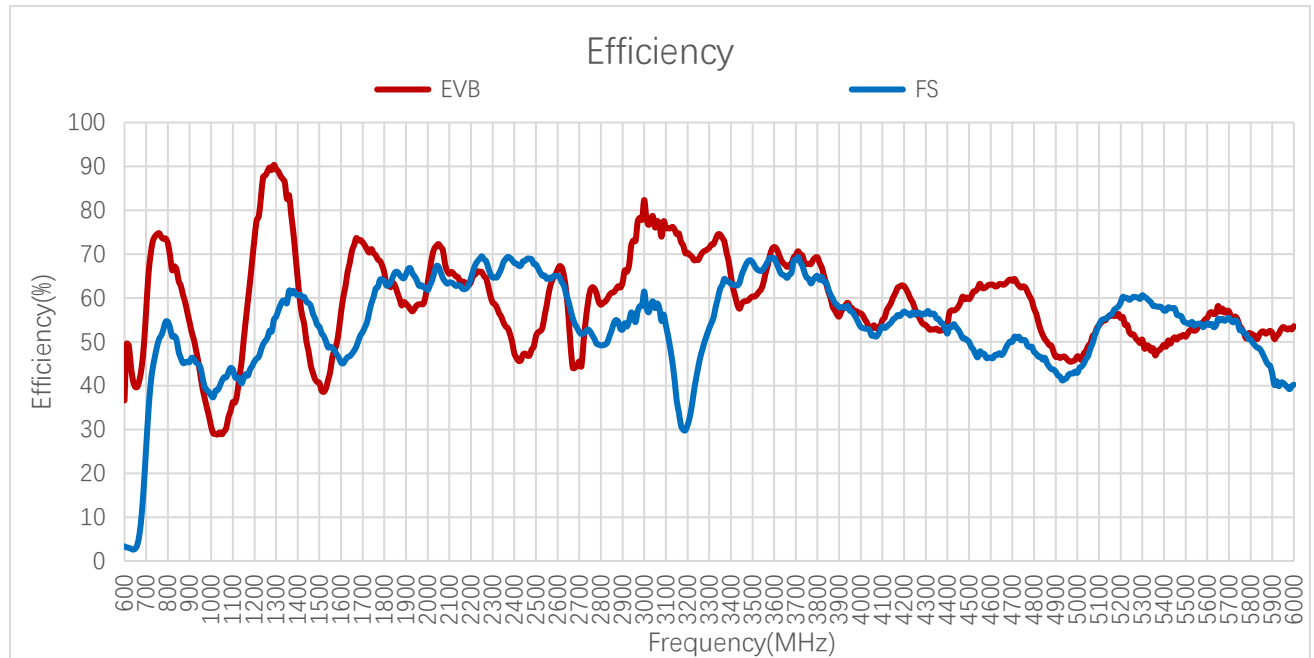


Return Loss (dB)

Frequency (MHz)		600	630	710	830	900	960	1440	1710	1740	1880
Return Loss (dB)	EVB	-13.1	-5.5	-5.3	-17.7	-7.1	-3.6	-6.3	-17.8	-14.6	-8.4
	FS	-1.3	-1.5	-5.6	-12.3	-13.9	-9.9	-10.7	-8.5	-10.6	-12.0
Frequency (MHz)		1950	2140	2350	2450	2600	3600	4700	5000	5500	6000
Return Loss (dB)	EVB	-9.3	-11.2	-8.1	-6.8	-19.7	-15.7	-26.0	-7.5	-11.0	-18.9
	FS	-9.0	-8.4	-18.8	-13.8	-16.3	-15.4	-12.4	-8.1	-10.8	-7.3

3.2. Radiation Performance Test

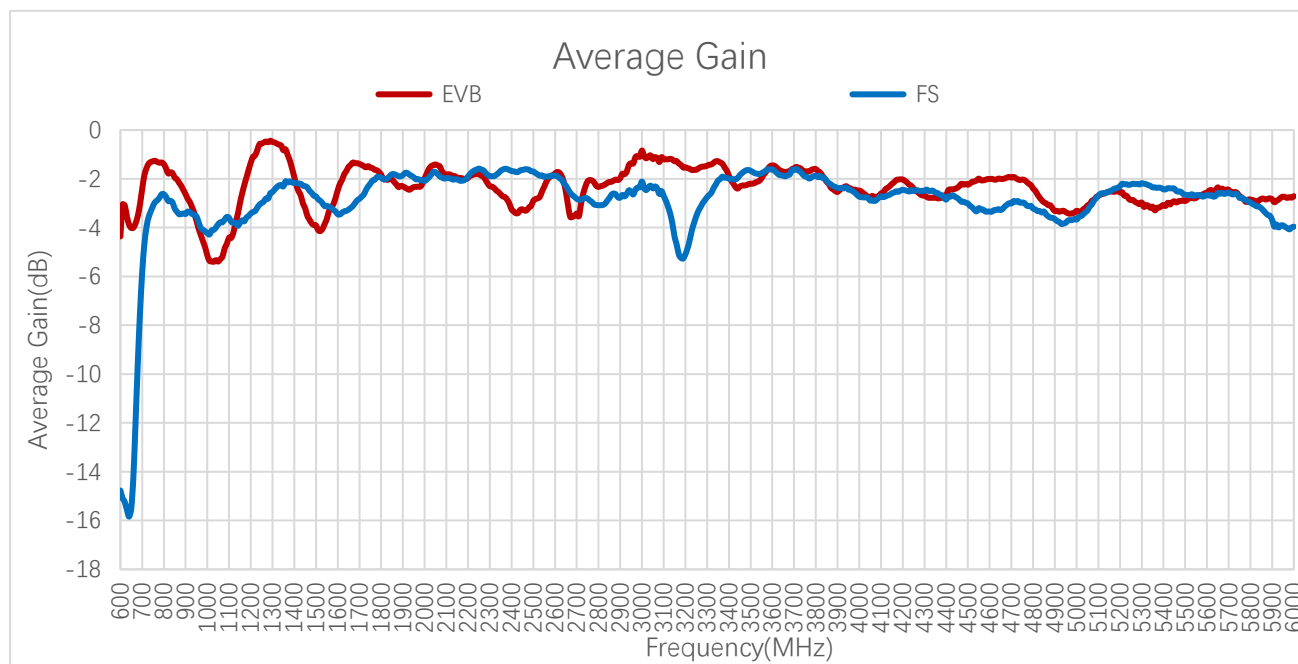
3.2.1. Efficiency



Efficiency (%)

Frequency (MHz)		600	630	710	830	900	960	1440	1710	1740	1880
Efficiency (%)	EVB	36.6	44.2	65.0	67.2	54.5	39.5	50.1	71.9	71.2	58.3
	FS	3.3	2.8	33.8	51.3	45.3	41.9	59.1	53.4	58.8	64.7
Frequency (MHz)		1950	2140	2350	2450	2600	3600	4700	5000	5500	6000
Efficiency (%)	EVB	58.3	64.8	54.4	47.3	66.4	71.6	63.9	46.7	51.1	53.6
	FS	64.0	62.9	68.1	68.5	65.0	69.1	50.0	42.9	54.4	40.2

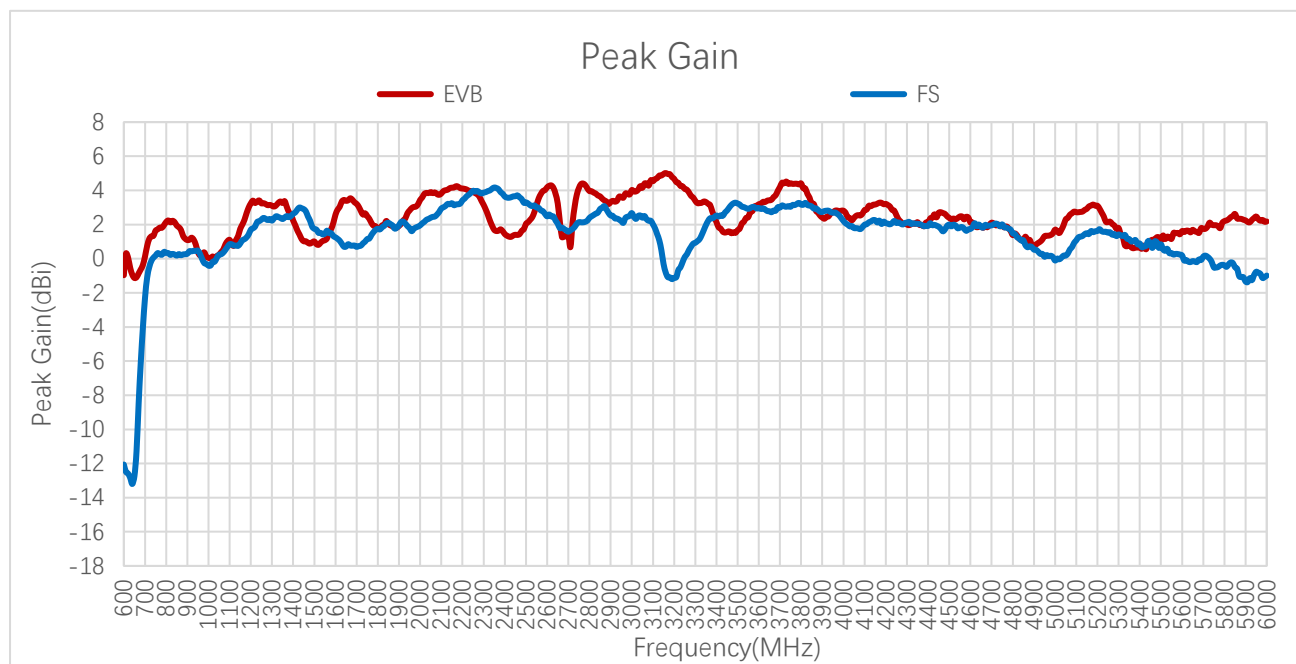
3.2.2. Average Gain



Average Gain (dB)

Frequency (MHz)		600	630	710	830	900	960	1440	1710	1740	1880
Average Gain (dB)	EVB	-4.4	-3.6	-1.9	-1.7	-2.6	-4.0	-3.0	-1.4	-1.5	-2.3
	FS	-14.8	-15.6	-4.7	-2.9	-3.4	-3.8	-2.3	-2.7	-2.3	-1.9
Frequency (MHz)		1950	2140	2350	2450	2600	3600	4700	5000	5500	6000
Average Gain (dB)	EVB	-2.3	-1.9	-2.6	-3.3	-1.8	-1.5	-2.0	-3.3	-2.9	-2.7
	FS	-1.9	-2.0	-1.7	-1.6	-1.9	-1.6	-3.0	-3.7	-2.7	-4.0

3.2.3. Peak Gain



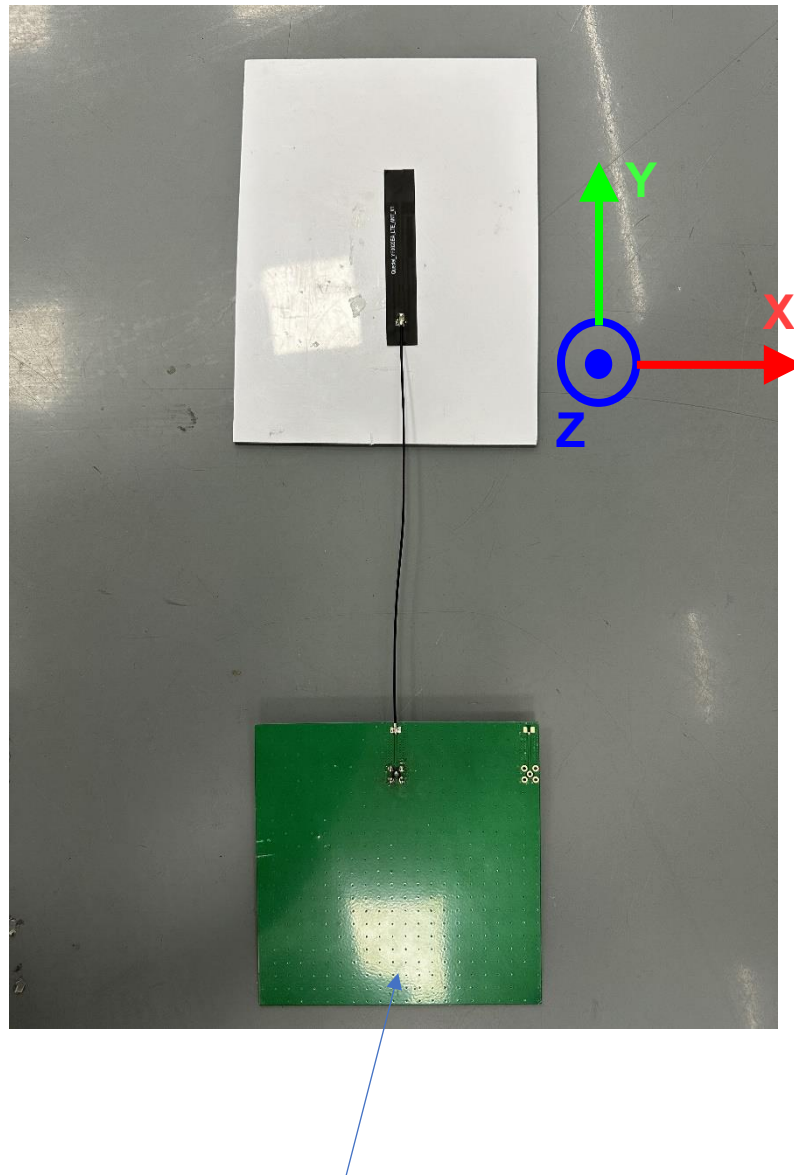
Peak Gain (dBi)

Frequency (MHz)		600	630	710	830	900	960	1440	1710	1740	1880
Peak Gain (dBi)	EVB	-1.0	-0.5	0.7	2.2	1.1	0.2	1.2	3.0	2.7	1.8
	FS	-12.1	-12.8	-1.1	0.3	0.3	0.3	3.0	0.7	1.0	1.8
Frequency (MHz)		1950	2140	2350	2450	2600	3600	4700	5000	5500	6000
Peak Gain (dBi)	EVB	2.8	4.1	1.7	1.4	4.2	3.2	2.1	1.7	1.1	2.2
	FS	1.8	3.2	4.2	3.7	2.5	3.0	2.0	-0.1	0.8	-1.0

3.2.4. 3D & 2D Radiation Pattern

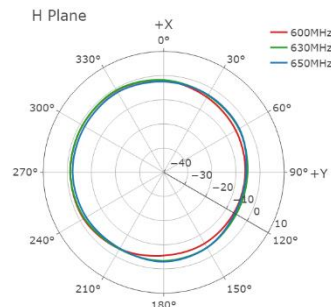
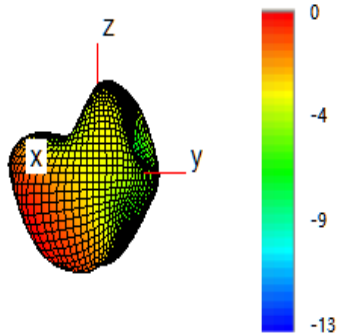
3.2.4.1. Test Condition: Stick to ABS Board on 130 × 130 mm EVB Board

- Test Chamber: HF-G-1

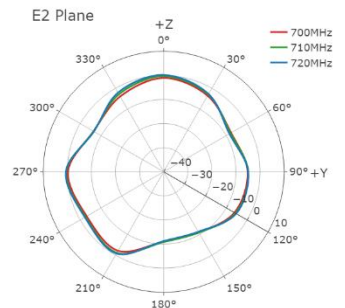
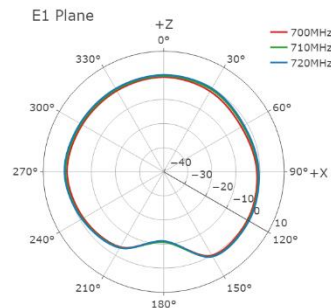
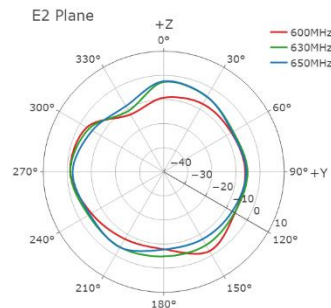
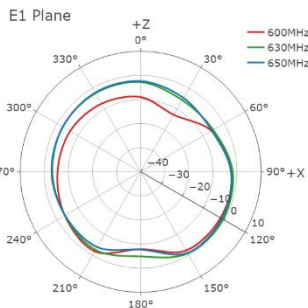
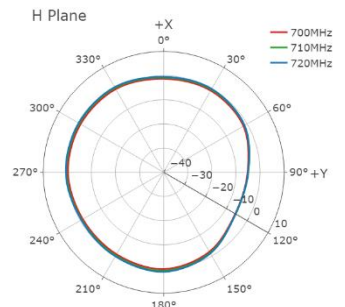
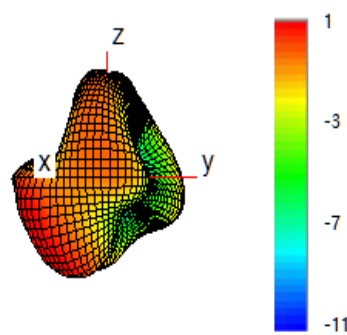


130 × 130 mm EVB

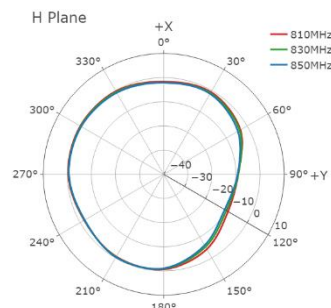
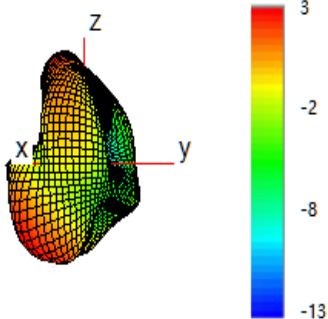
630 MHz



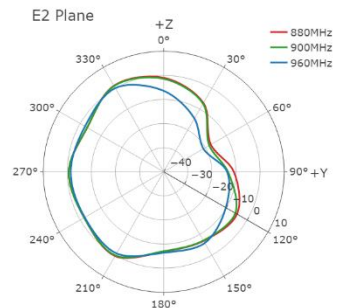
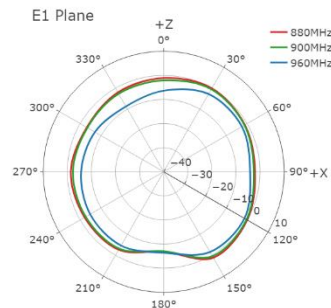
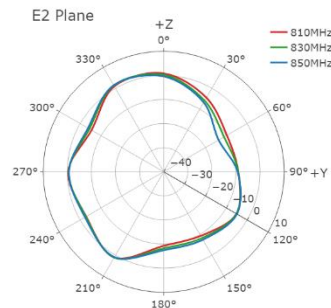
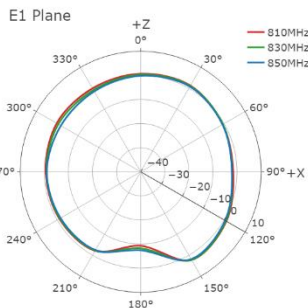
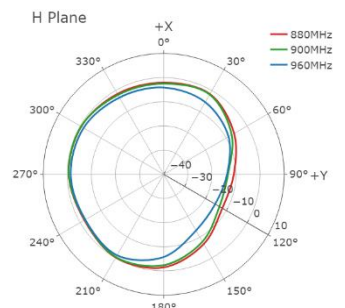
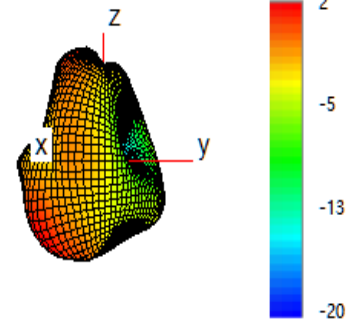
710 MHz

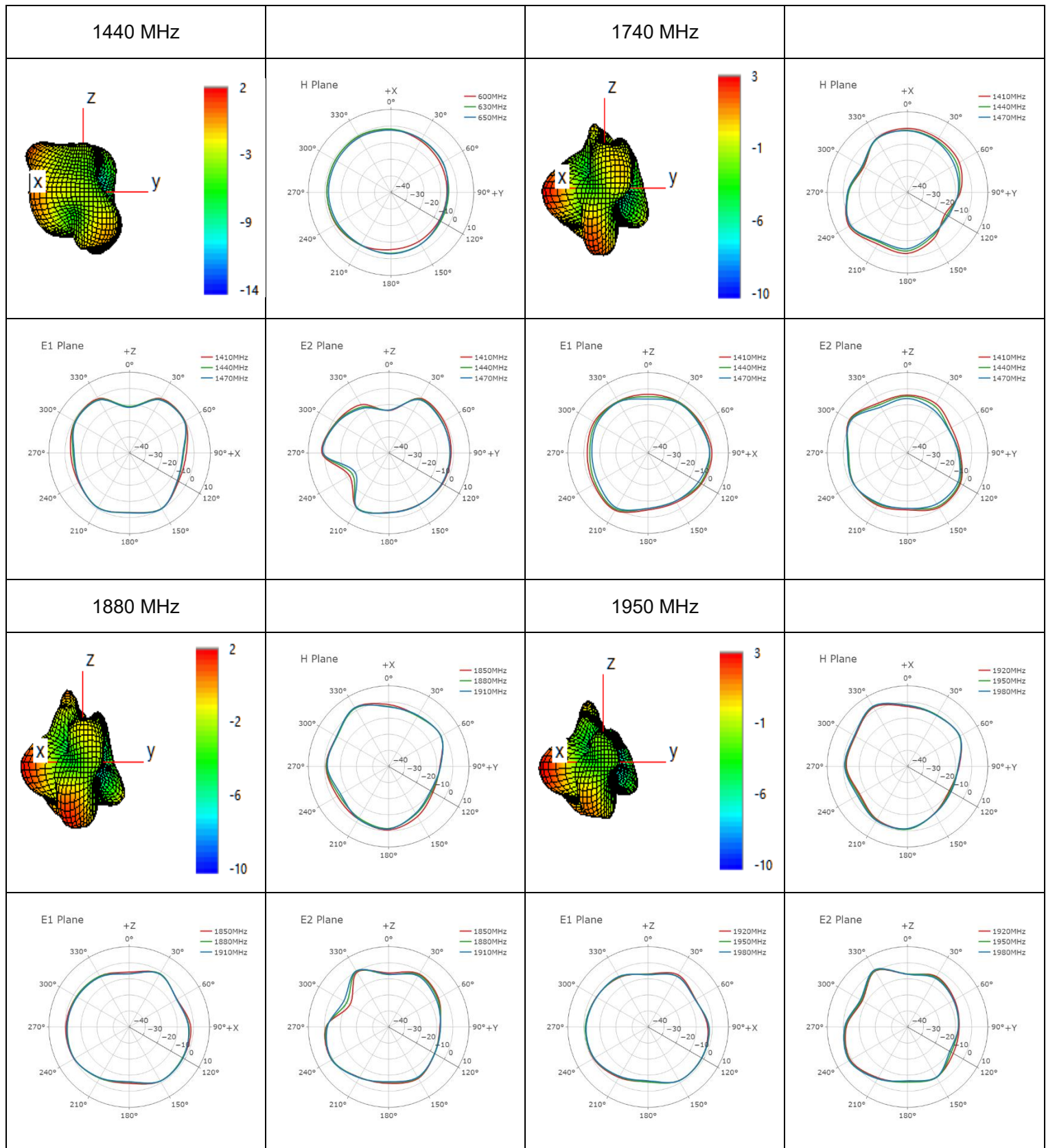


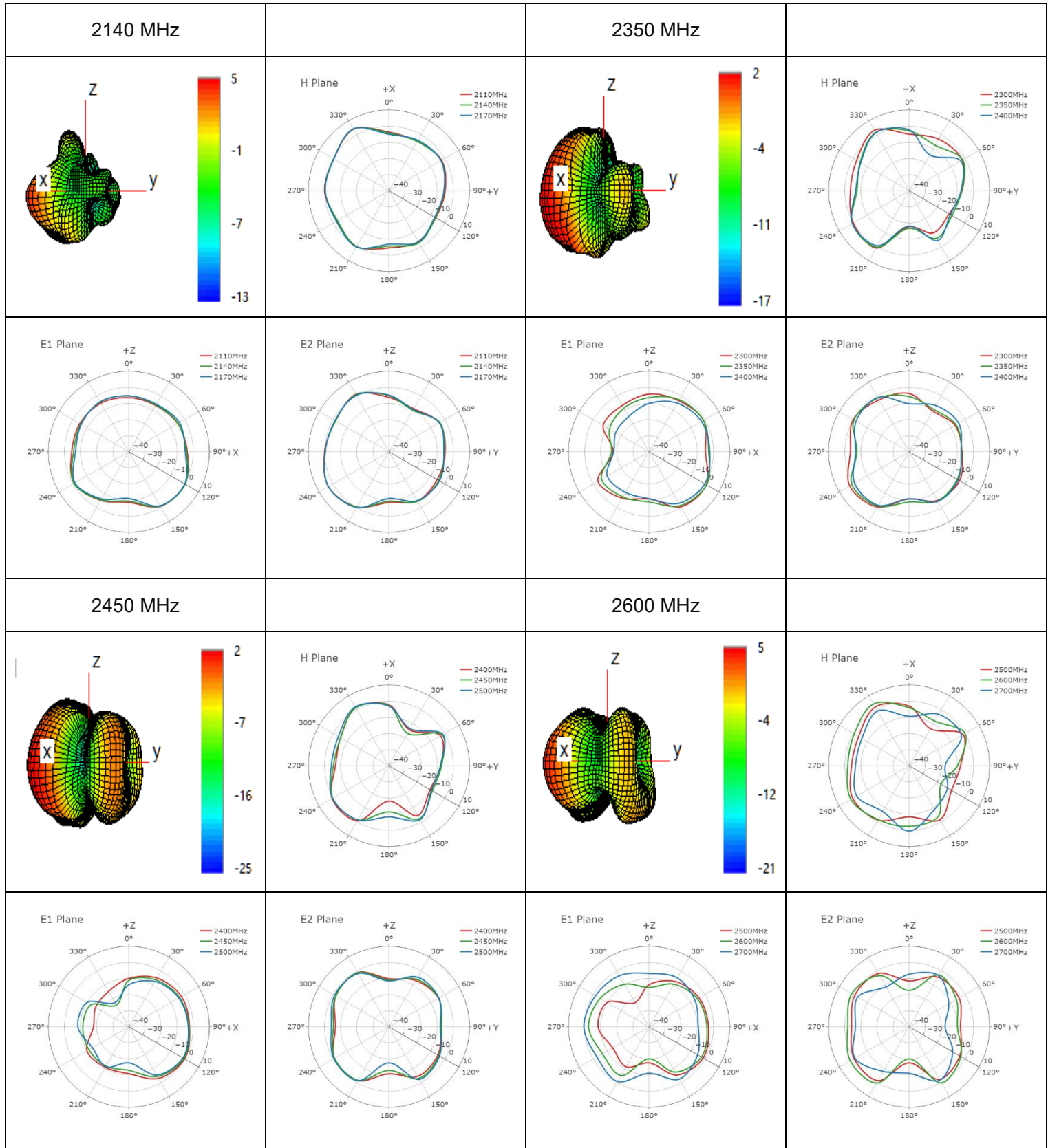
830 MHz

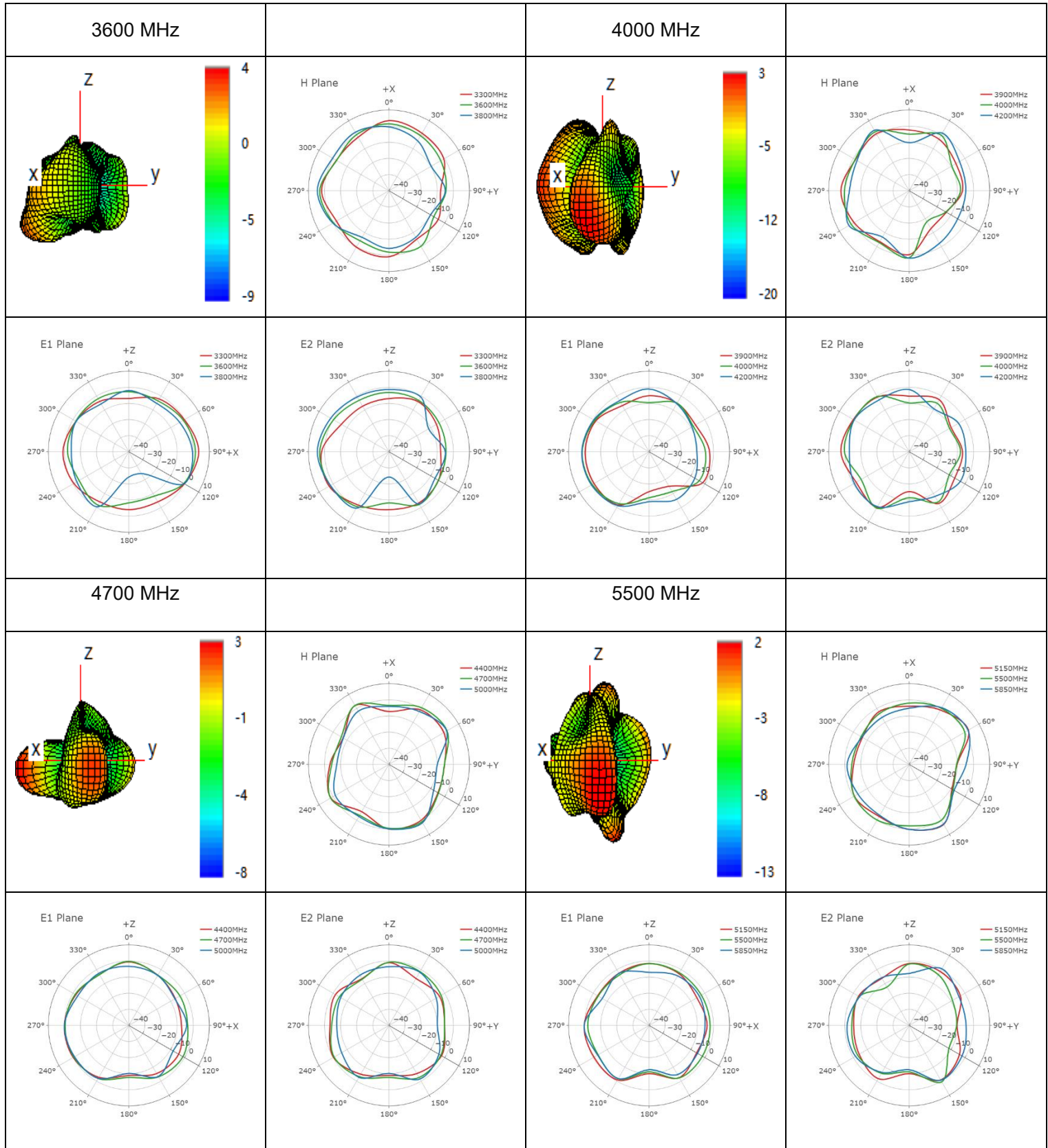


900 MHz



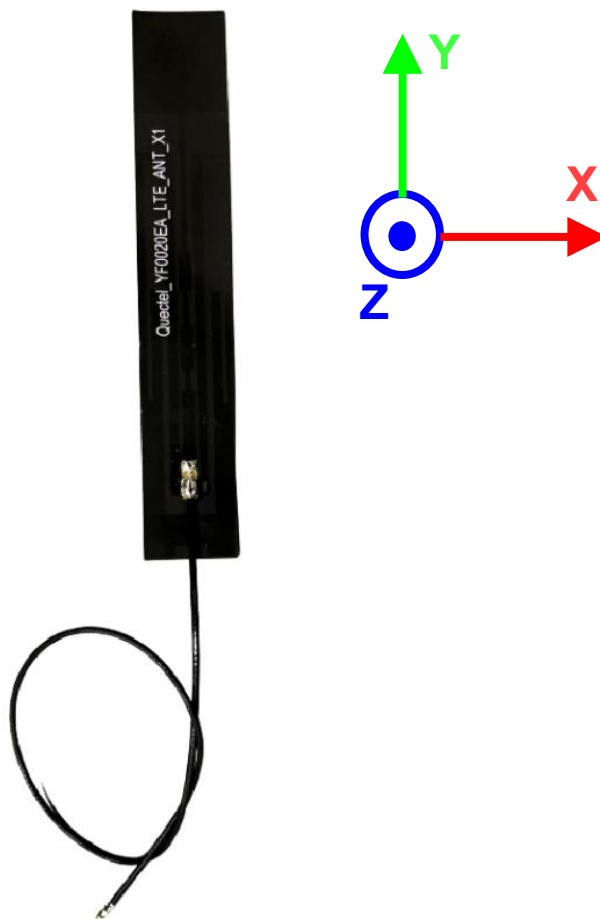




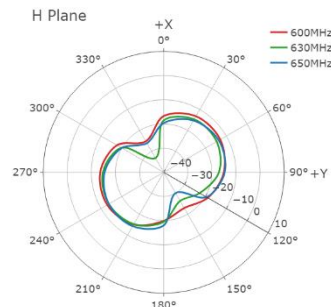
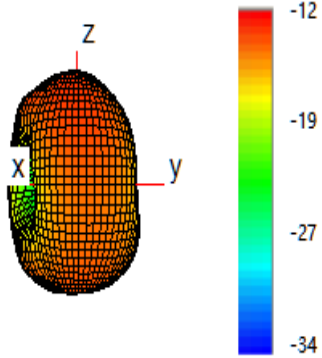


3.2.4.2. Test Condition: Free Space

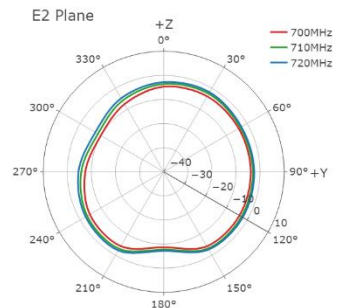
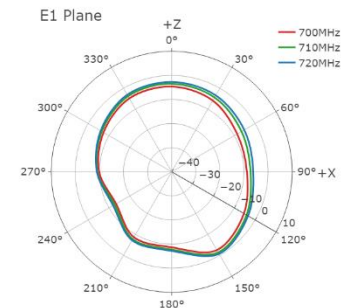
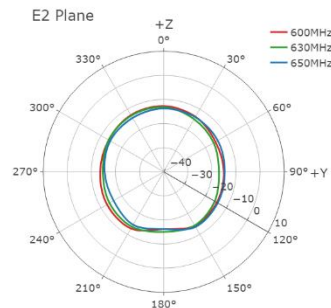
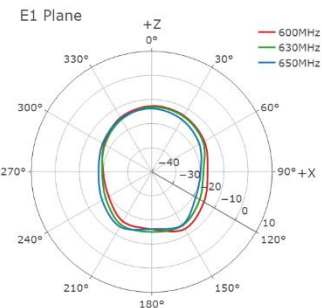
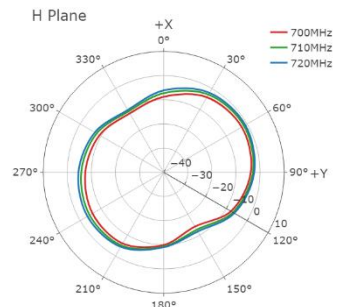
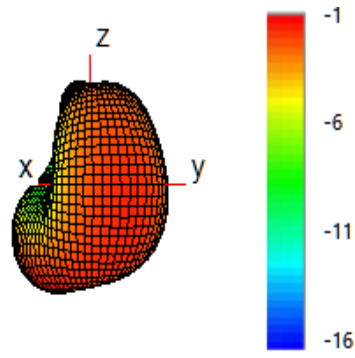
- Test Chamber: HF-G-1



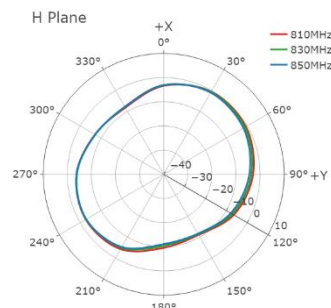
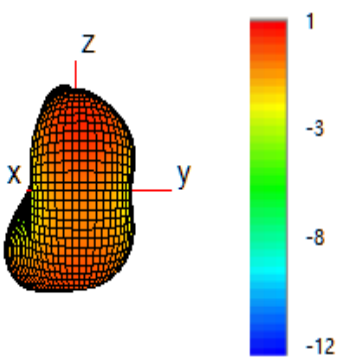
630 MHz



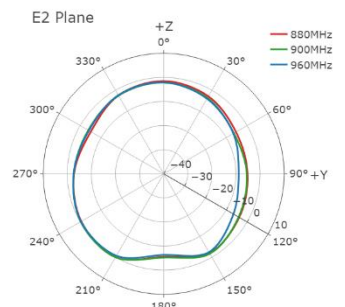
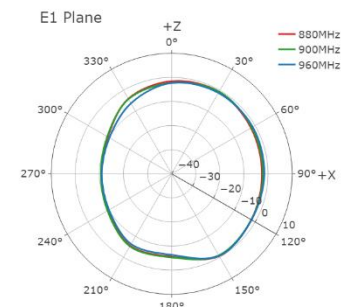
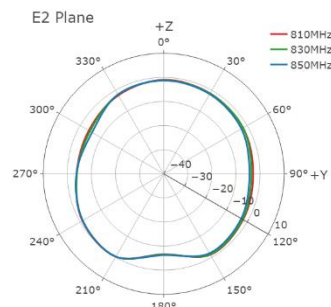
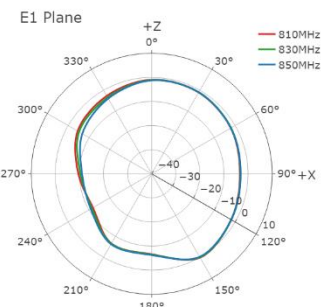
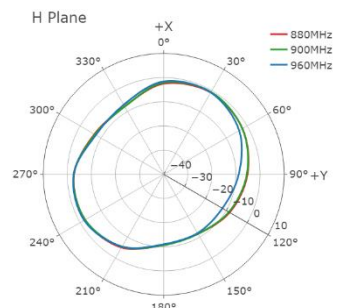
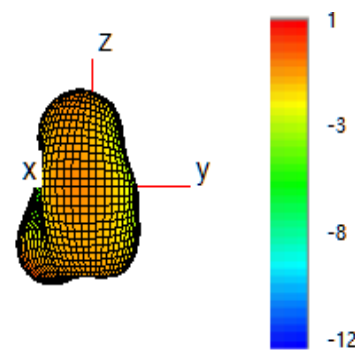
710 MHz

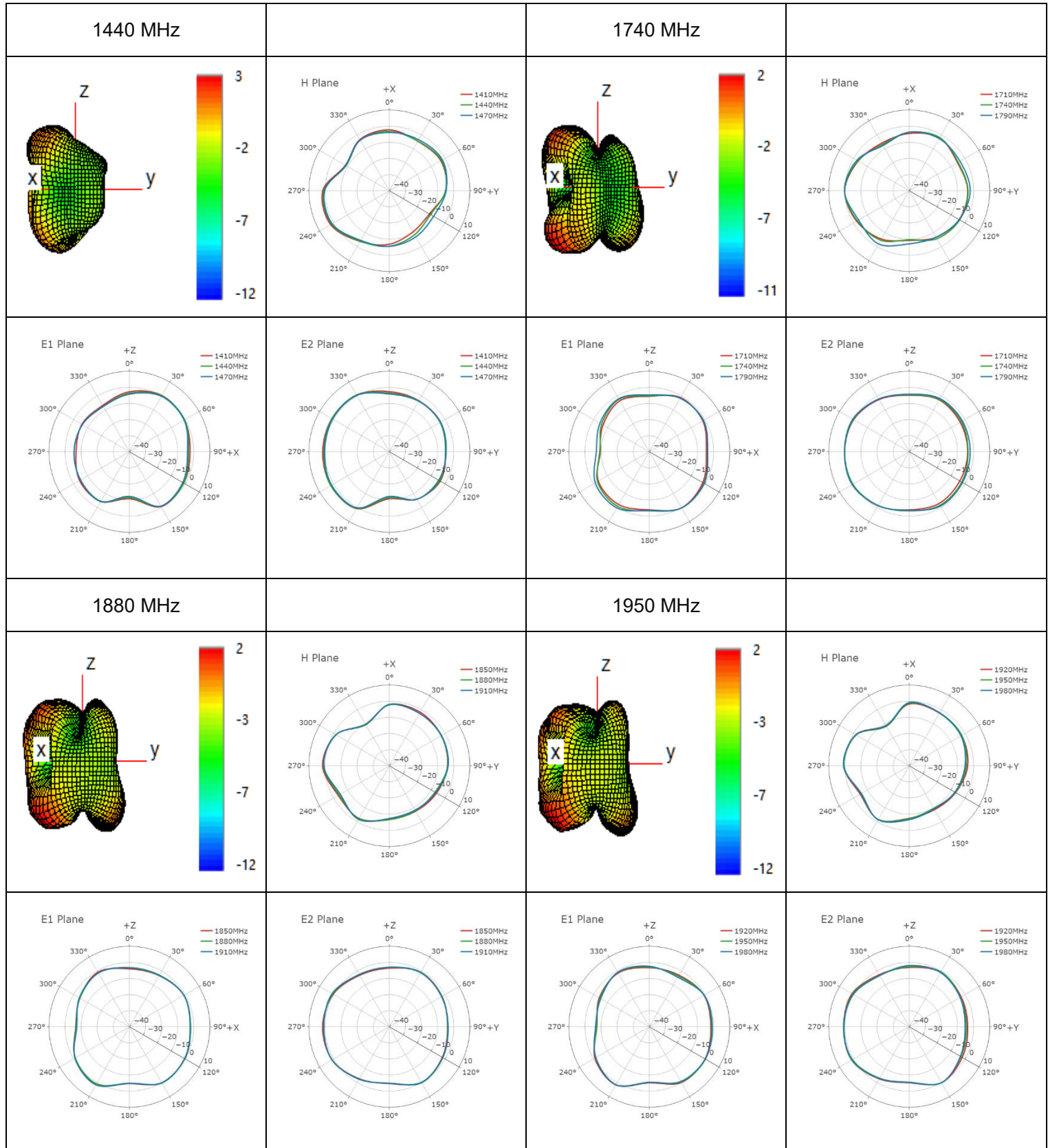


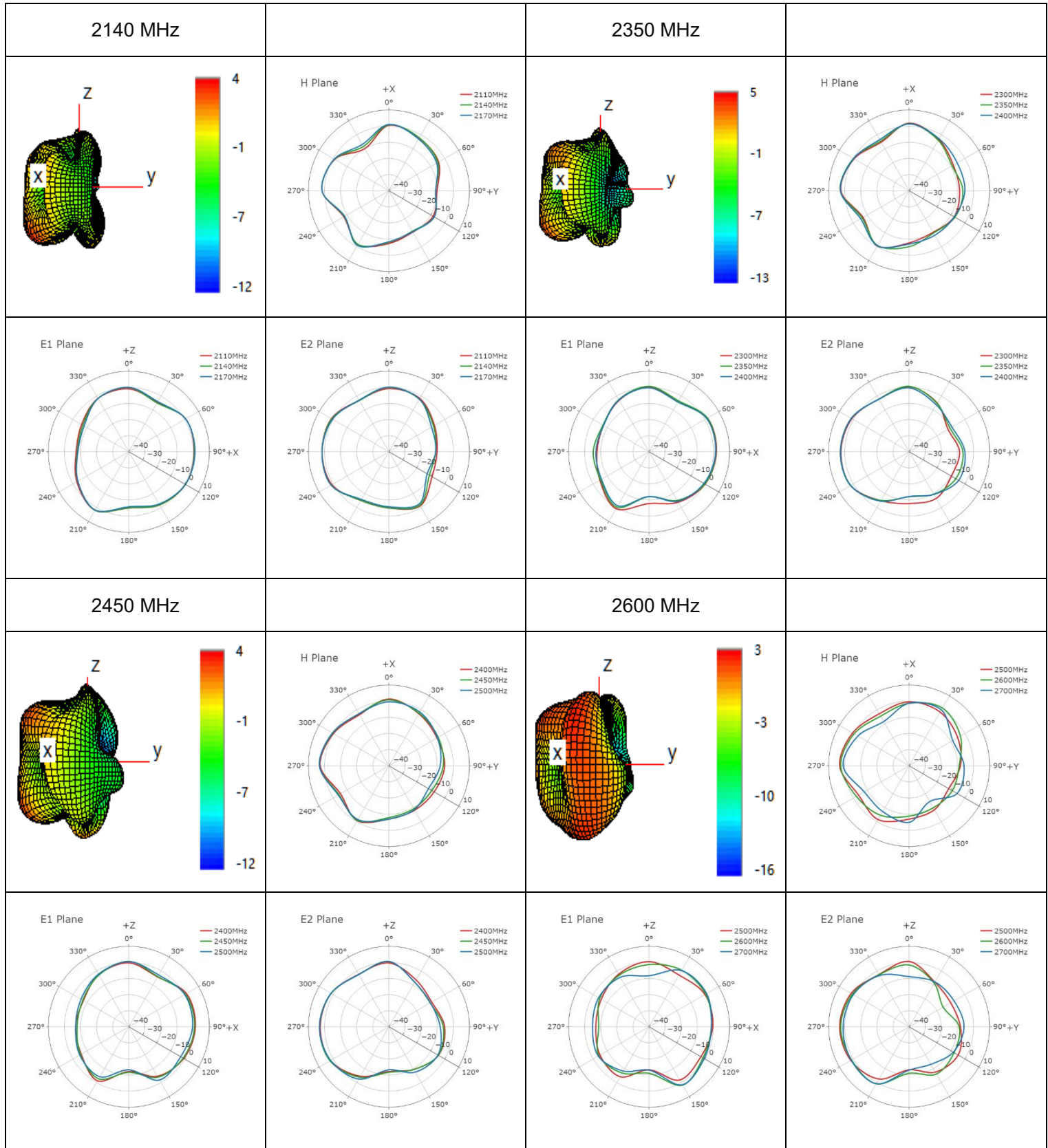
830 MHz

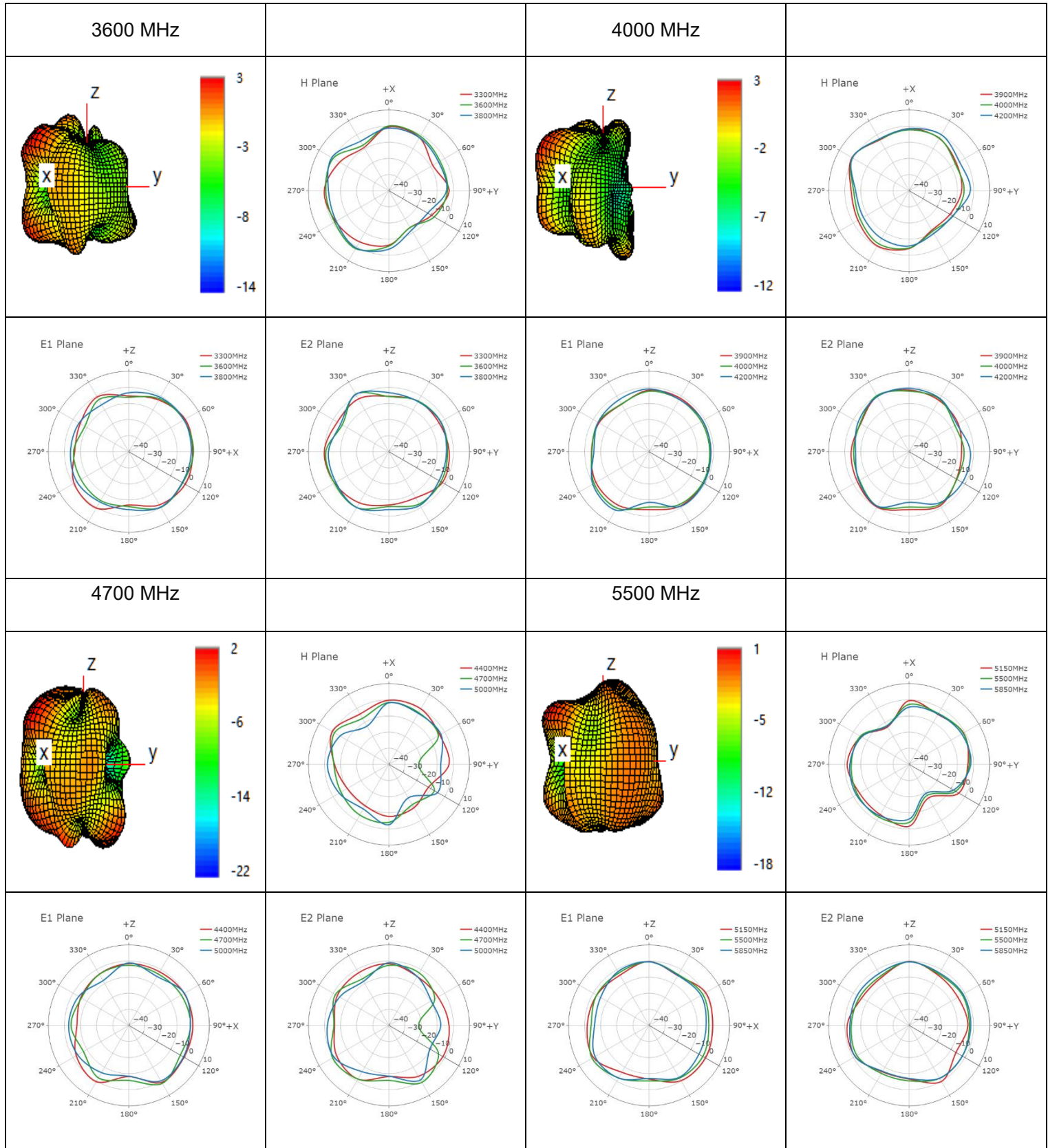


900 MHz

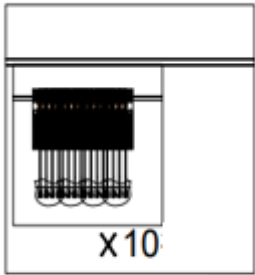
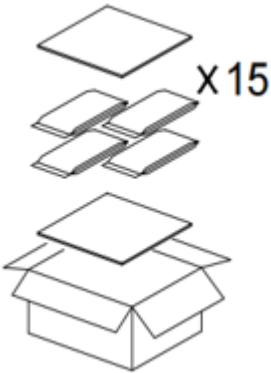


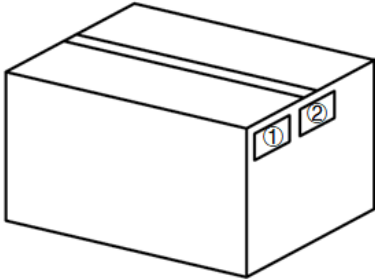
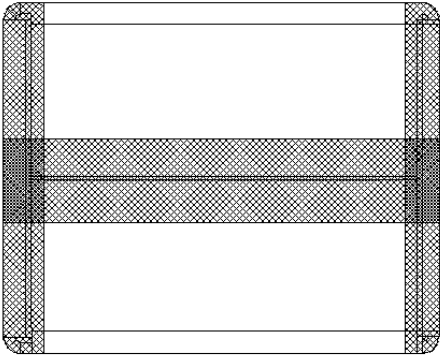






4 Packaging

Step	Packaging Picture / 2D Picture	Description
1	 20pcs/tie	The product terminal is wrapped with EPE foam, 20 PCS/ Tie.
2	 200pcs/bag	200 pcs antenna products in a PE bag. (200 PCS / PE Bag)
3		15 PE Bags / Carton Box (3000 PCS / Carton Box) Estimated Quantity Products that cannot fill the entire carton box are packed in a suitable size carton box. <u>Carton Size:</u> <u>L × W × H = 340 × 260 × 140 mm</u>

4		Position for Attaching Labels ① Carton Label ② Quality Label
5		Sealing Cartons “I” type sealing cartons
Note	The initial packaging method described above is for reference only, and the final actual packaging method shall be subject to the actual shipping packaging.	

Contact Us

At Quectel, our aim is to provide timely and comprehensive services to our customers. If you require any assistance, please contact our headquarters:

Quectel Wireless Solutions Co., Ltd.

Building 5, Shanghai Business Park Phase III (Area B), No.1016 Tianlin Road, Minhang District, Shanghai 200233, China

Tel: +86 21 5108 6236

Email: info@quectel.com

Or our local offices. For more information, please visit:

<http://www.quectel.com/support/sales.htm>.

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Revision History

Version	Date	Author	Note
-	2022-07-25	Simon SHENG/ Joye WANG	Creation of the document
1.0	2022-12-31	Simon SHENG/ Joye WANG	First official release
1.1	2023-06-12	David LIU/ Vinnie LIU	Added the packaging information (Chapter 6)
2.0	2023-10-26	Lee CAO/ Joye WANG/ David LIU/ Aria CHU	Numerous changes were made to this document. It should be read in its entirety.
2.1	2024-06-07	Joye WANG	Updated the drawing (Chapter 2).



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